MOSFET – Power, Single N-Channel

60 V, 0.81 mΩ, 398.2 A

NVMTS001N06CL

Features

- Small Footprint (8x8 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Power 88 Package, Industry Standard
- AEC-Q101 Qualified and PPAP Capable
- Wettable Flank Plated for Enhanced Optical Inspection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS	$(1_{\rm J} = 25^{-1})$	J unless otherw	nse noted)		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	60	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	398.2	А
Current R _{θJC} (Notes 1, 3)	Steady State	T _C = 100°C		281.6	
Power Dissipation		T _C = 25°C	PD	244.0	W
$R_{\theta JC}$ (Note 1)		T _C = 100°C		122.0	
Continuous Drain		T _A = 25°C	۱ _D	56.9	А
Current R _{θJA} (Notes 1, 2, 3)	Steady State	$T_A = 100^{\circ}C$		40.2	
Power Dissipation		T _A = 25°C	PD	5.0	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		2.5	
Pulsed Drain Current	T _A = 25	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		900	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	203.4	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 30 \text{ A}$)			E _{AS}	887	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

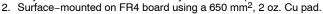
MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.614	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	30.1	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



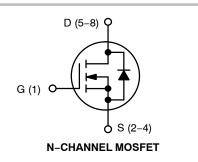
Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

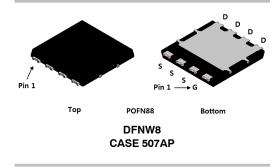


ON Semiconductor®

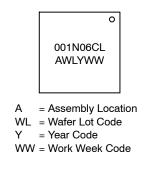
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V _{(BR)DSS}	R _{DS(ON)} MAX I _D MAX		
60 V	0.81 mΩ @ 10 V	000.0.4	
00 V	1.05 m Ω @ 4.5 V	398.2 A	





MARKING DIAGRAM



ORDERING INFORMATION

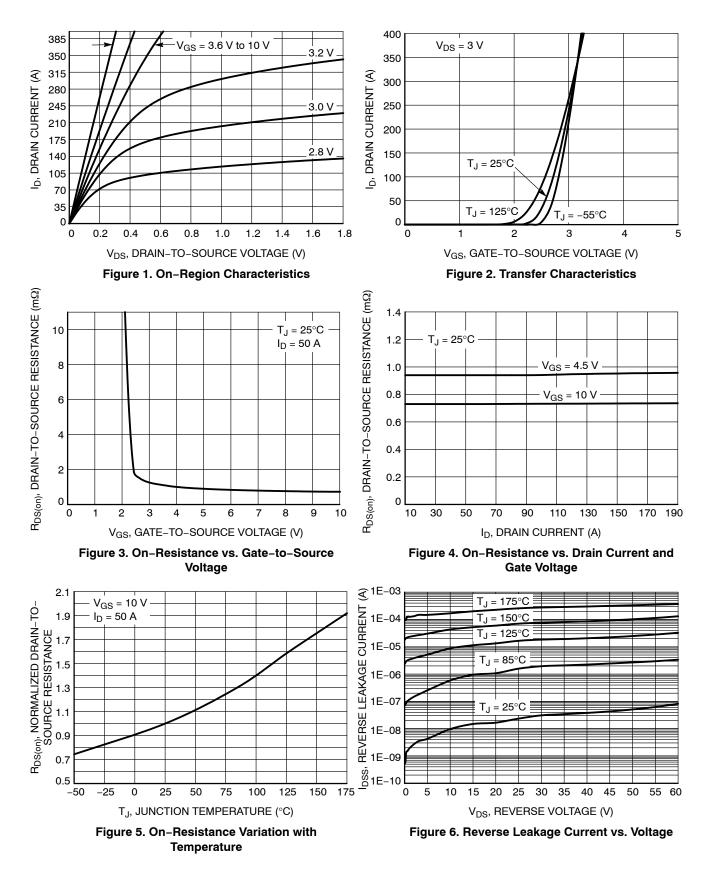
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

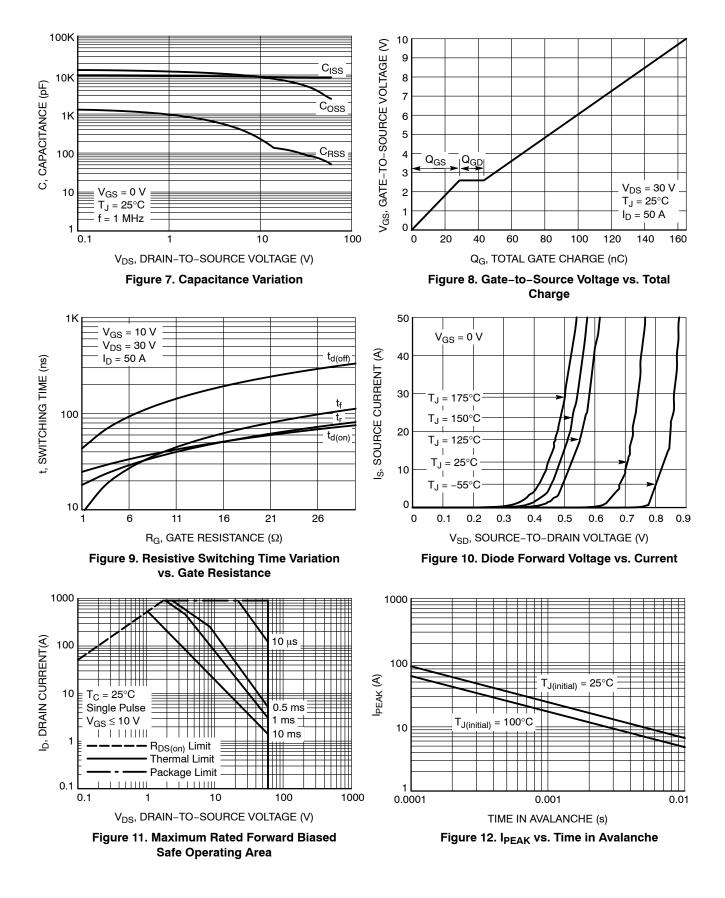
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu A$, ref to $25^{\circ}C$			25		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			10	
		V _{DS} = 60 V	T _J = 125°C			250	μA
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D =	= 250 μA	1.2		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 250 μA, ref	to 25°C		-5.53		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.73	0.81	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		0.94	1.05	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D	= 50 A		275		S
CHARGES, CAPACITANCES & GATE RES	ISTANCE						
Input Capacitance	C _{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 25 V V_{GS} = 10 V, V_{DS} = 30 V; I _D = 50 A			12300		
Output Capacitance	C _{OSS}				6225		pF
Reverse Transfer Capacitance	C _{RSS}				130		
Total Gate Charge	Q _{G(TOT)}				165		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 50 A			74.3		nC
Threshold Gate Charge	Q _{G(TH)}				15.6		
Gate-to-Source Charge	Q _{GS}				28.7		nC
Gate-to-Drain Charge	Q _{GD}				14.7		
Plateau Voltage	V _{GP}				2.59		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn–On Delay Time	t _{d(ON)}				47.2		
Rise Time	t _r	V _{GS} = 4.5 V. V _D	s = 30 V.		25.2		ns
Turn-Off Delay Time	t _{d(OFF)}	V _{GS} = 4.5 V, V _{DS} I _D = 50 A, R _G =	2.5 Ω		70.7		
Fall Time	t _f				23.3		1
DRAIN-SOURCE DIODE CHARACTERIST	ICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.77	1.2	
		$I_{\rm S} = 50 \rm A$	T _J = 125°C		0.63		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/μs, I _S = 50 A			98.9		
Charge Time	t _a				66.8		ns
Discharge Time	t _b				32.1		1
Reverse Recovery Charge	Q _{RR}				229		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

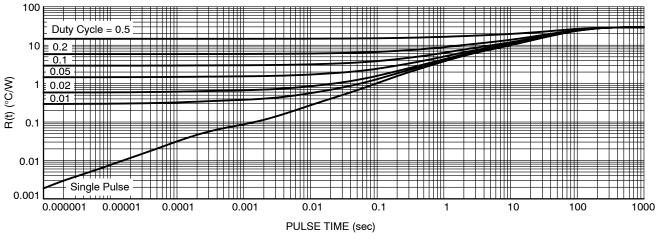


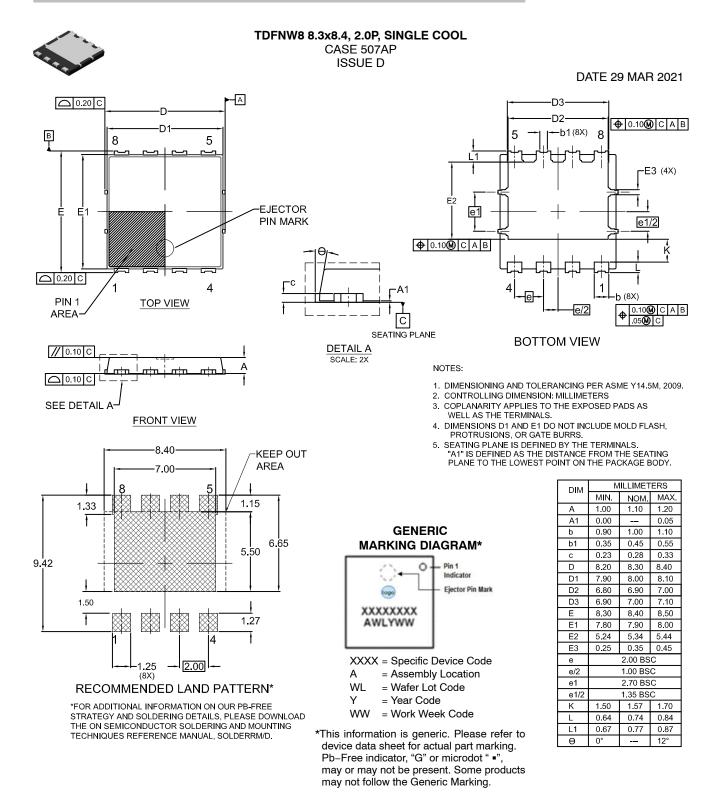
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMTS001N06CLTXG	001N06CL	DFNW8 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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